

18-6503-30 Information

Heisener.com

Manuf

18-6503-30

Manufacturer Aries Electronics

Category

Part Number

Connectors, Interconnects

Sockets for ICs, Transistors

Description

CONN IC DIP SOCKET 18POS GOLD

Package -

For the pricing/inventory/lead time, please contact

us

Website: https://www.heisener.com E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

For Reference Only

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









18-6503-30 Specifications

Manufacturer Part Number	18-6503-30	
Manufacturer	Aries Electronics	
Category	Connectors, Interconnects	
	Sockets for ICs, Transistors	
Package	-	
Series	503	
Туре	DIP, 0.6" (15.24mm) Row Spacing	
Number of Positions or Pins (Grid)	18 (2 x 9)	
Pitch - Mating	0.100" (2.54mm)	
Contact Finish - Mating	Gold	
Contact Finish Thickness - Mating	10μin (0.25μm)	
Contact Material - Mating	Beryllium Copper	
Mounting Type	Through Hole	
Features	Closed Frame	
Termination	Wire Wrap	
Pitch - Post	0.100" (2.54mm)	
Contact Finish - Post	Tin	
Contact Finish Thickness - Post	200μin (5.08μm)	
Contact Material - Post	Phosphor Bronze	
Housing Material	Polyamide (PA46), Nylon 4/6, Glass Filled	
Operating Temperature	-55°C ~ 105°C	
		Report errors?

18-6503-30 Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

18-6503-30 Payment Methods





















18-6503-30 Shipping Methods













If you have any question about 18-6503-30, please do not hesitate to contact us!

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